



3672-0110P

Applicant:	Lucimara ROMAN et al.	Conf.:	9297
Appl. No.:	09/720,329 ✓	Group:	2818
Filed:	February 6, 2001	Examiner:	David Vu
For:	A METHOD IN FABRICATION OF ORGANIC THIN FILM SEMICONDUCTOR SERVICES		

	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR		PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	8	-	20	=	0	\$ 18	\$0.00
INDEPENDENT	1	-	3	=	0	\$ 86	\$0.00
<input type="checkbox"/> FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						\$290	\$0.00
						TOTAL	\$0.00

Appl. No. 09/720,329

- ☐ Petition for () month(s) extension of time pursuant to 37 C.F.R. §§ 1.17 and 1.136(a). \$0.00 for the extension of time.
- ☒ No fee is required.
- ☐ Check(s) in the amount of \$0.00 is being paid concurrently with the Notice of Appeal.
- ☐ Please charge Deposit Account No. 02-2448 in the amount of \$0.00. This form is submitted in triplicate.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By ma c 18
Michael K. Mutter, #29,680

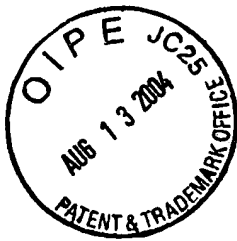
MaryAnne Armstrong, PhD., #40,069

MKM/MAA/csm
3672-0110P

P.O. Box 747
Falls Church, VA 22040-0747
(703) 205-8000

Attachment(s)

(Rev. 09/30/03)



MS ISSUE FEE
PATENT
3672-0110P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Lucimara S. ROMAN et al. Conf.: 9297
Appl. No.: 09/720,329 Group: 2818
Filed: February 6, 2001 Examiner: D. VU
For: A METHOD IN THE FABRICATION OF ORGANIC THIN-
FILM SEMICONDUCTING DEVICES

AMENDMENT UNDER 37 C.F.R. § 1.312

MS ISSUE FEE

August 13, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to the provisions of 37 C.F.R. § 1.312, the following amendments and remarks are respectfully submitted in connection with the above-identified application. It is respectfully requested that the following amendments be entered without withdrawing the application from issue.

This amendment includes amendments to the specification.